

# **DESIGNCON<sup>®</sup> 2014**

## **Mixed-Reference for Optimum Cost & Performance in High-Speed Memory Interface**

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**NVIDIA.**

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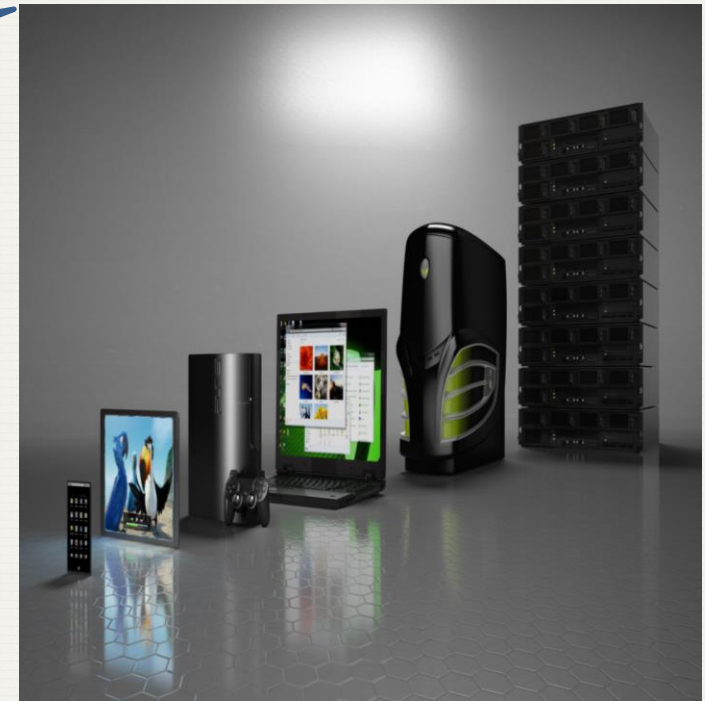


# Content

- Introduction
- Mixed-Reference Analysis using 3D Tool
- Expected SI/PI Issues from Mixed-Reference
- Mixed-Reference Impact on System Performance
- Summary



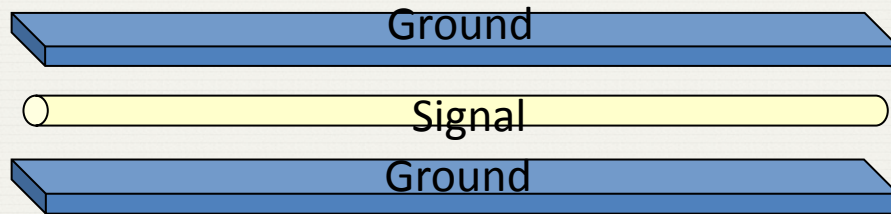
# Motivation



- Cost reduction is valuable in making products competitive
  - Reducing substrate layer-count/decaps greatly lowers the cost: \$\$\$
  - Cost reduction requires careful SI/PI analysis not to lose performance

# Why and What is Mixed-Reference?

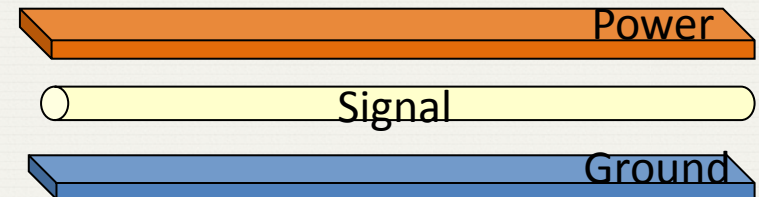
## Single-reference



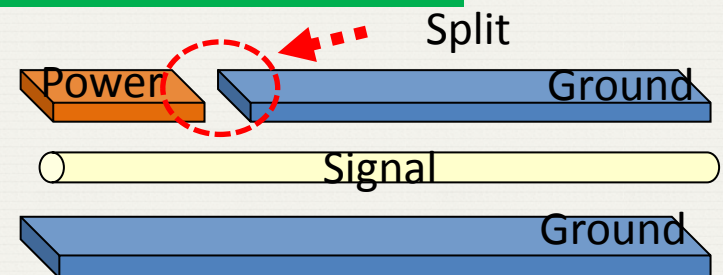
- Ideal reference type for minimizing SI issues
- Reducing substrate layer count typically leads to evaluate mixed-reference option

## Mixed-reference

### Power/ground reference



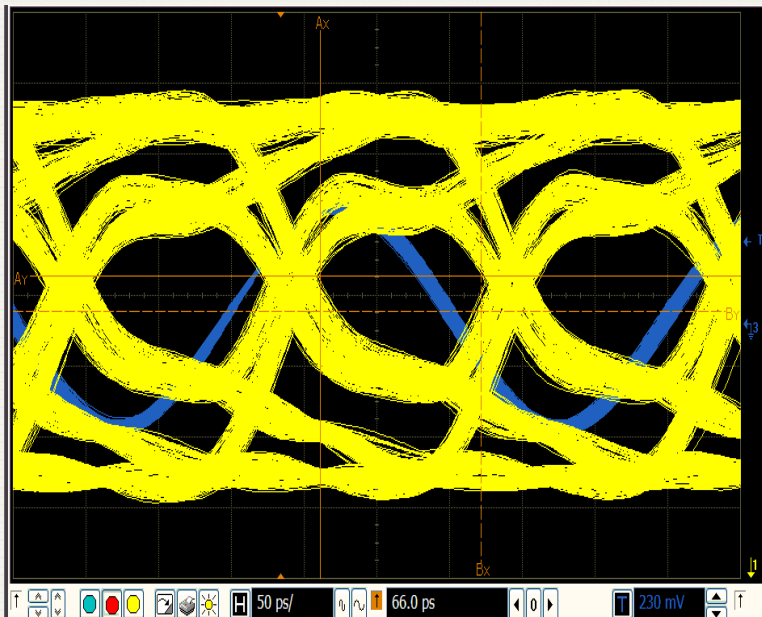
### Split-plane reference



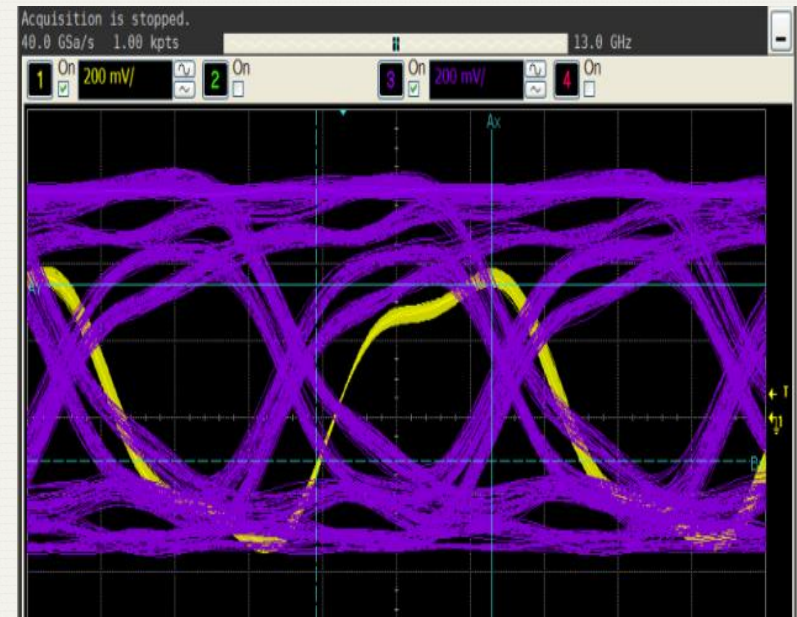


# Measured Performance Difference on Mixed-Reference at 6.6 Gbps

Split-plane reference



Single-reference



- Why do we see performance difference?
- How do we analyze mixed-reference?

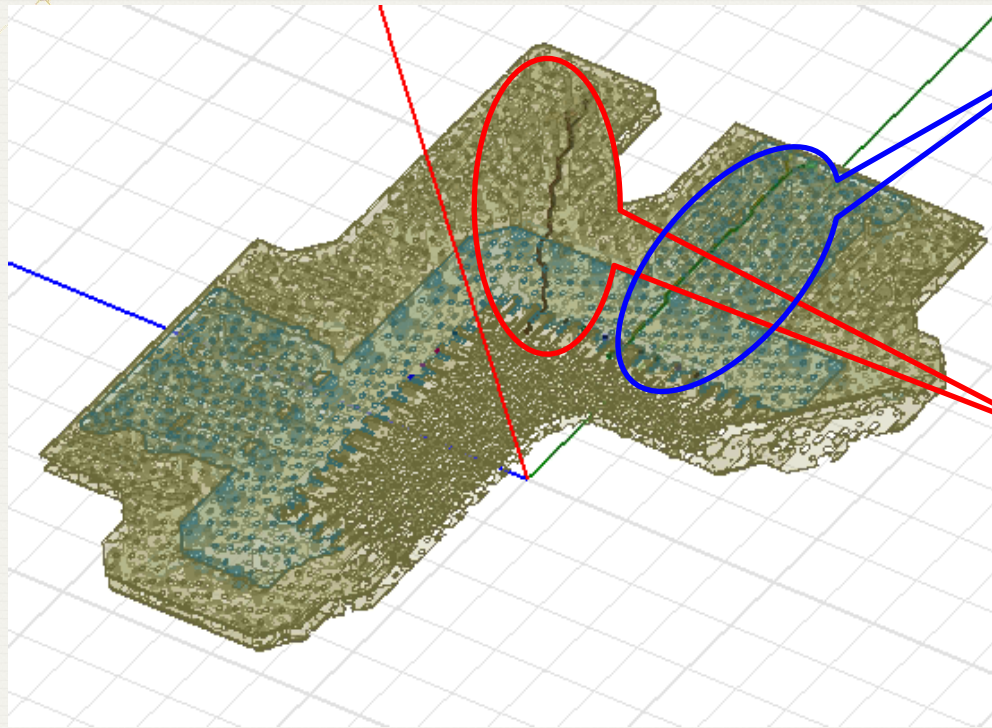
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# Need for SI/PI Co-Simulation Model

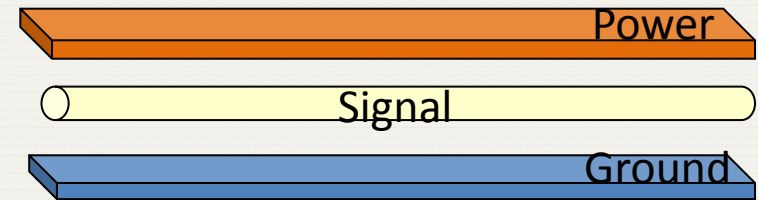
- Generally, SI and PI are modelled separately using different tools
  - Computationally expensive
- Mixed-reference analysis needs to use SI/PI combined model
  - Additional power noise directly coupled to channel response



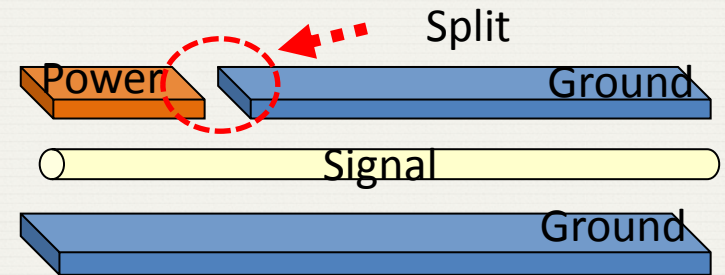
# SI/PI Co-Simulation 3D Model for Mixed-Reference



Power/ground reference



Split-plane reference



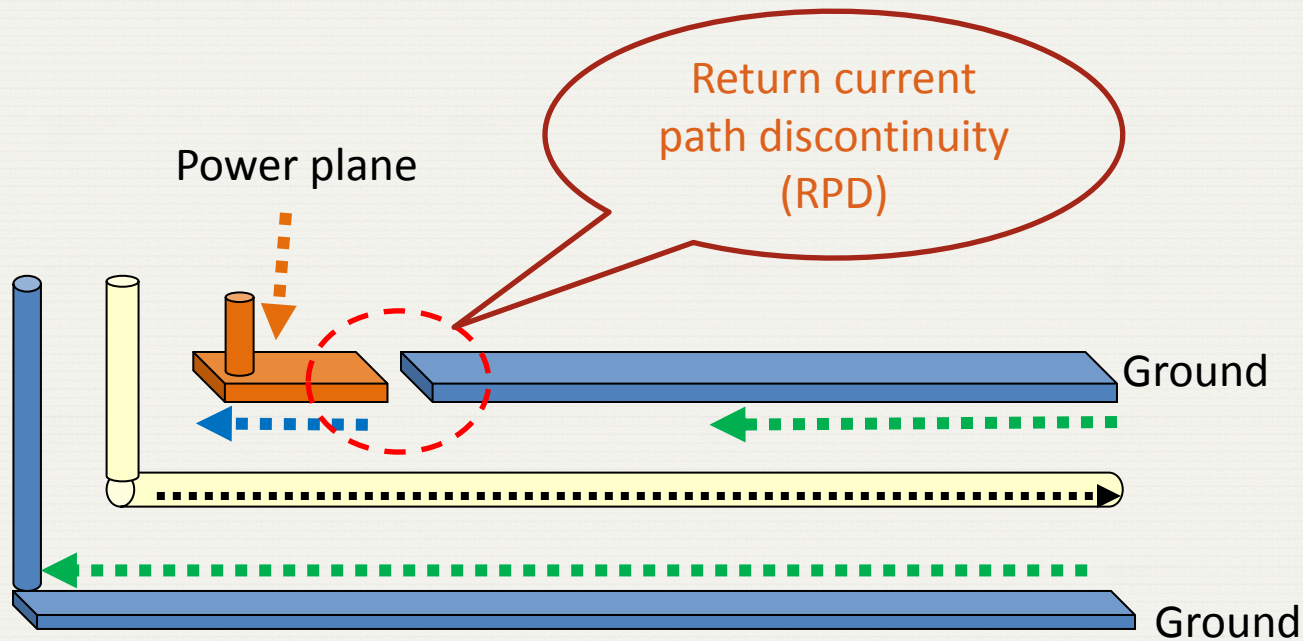
- PI: Entire PDN model
- SI: Mixed-reference channels



# Caveat on 3D Model Generation Flow for Mixed-Reference Analysis

- By default, auto port generation feature **shorts power and ground** when it generates signal ports
  - For single-reference channel, signal port referenced to ground **without shorting power and ground** should give identical results as automatically generated one
- For mixed-reference analysis, power and ground connection for port definition greatly affects the result

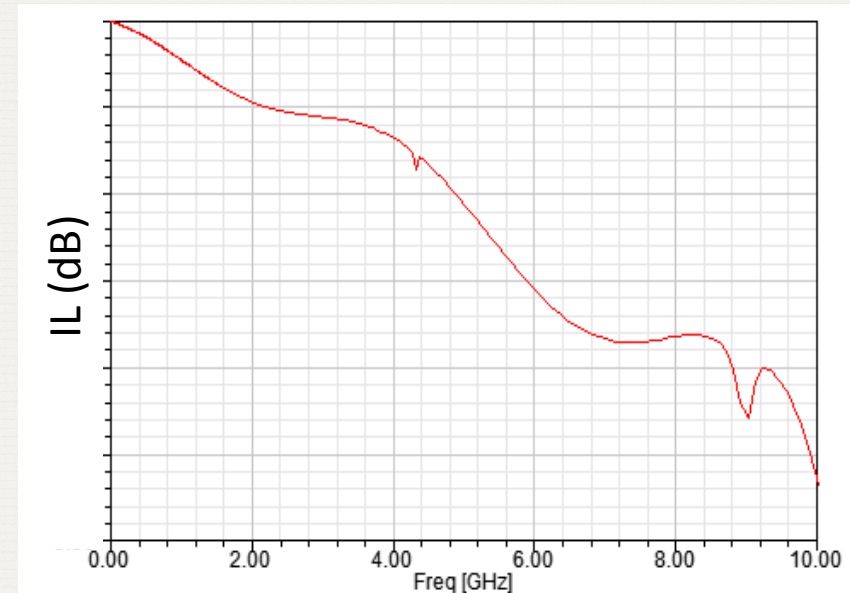
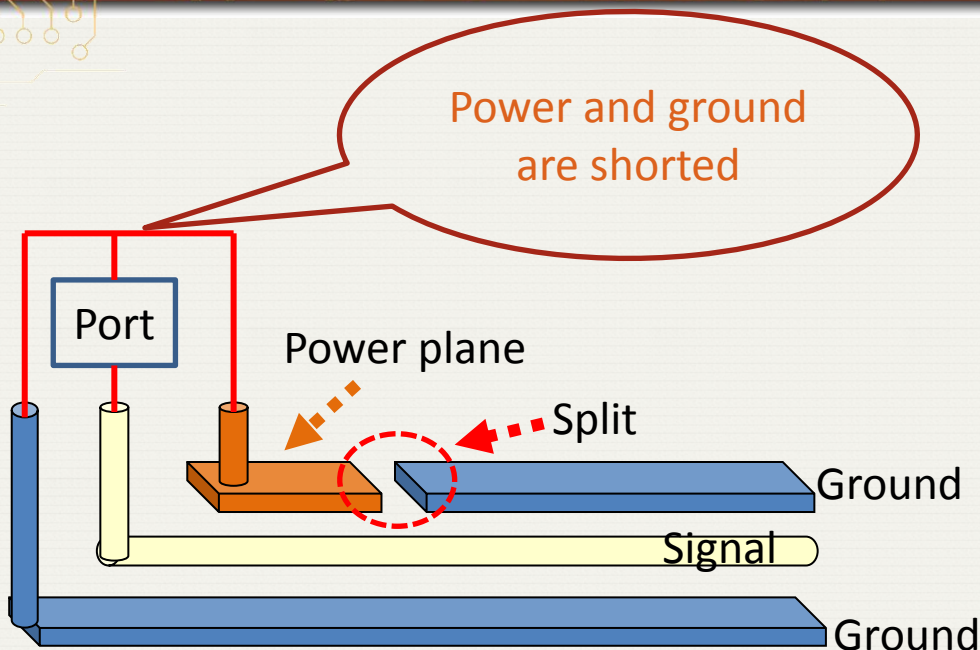
# Return Path Discontinuity on Split Plane



- Expect to have RPD effect, which will affect signal integrity

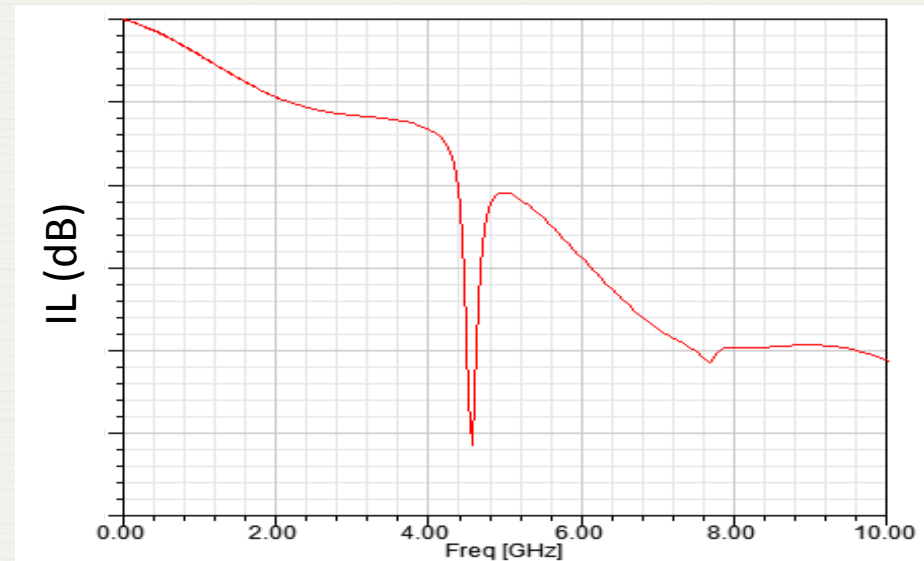
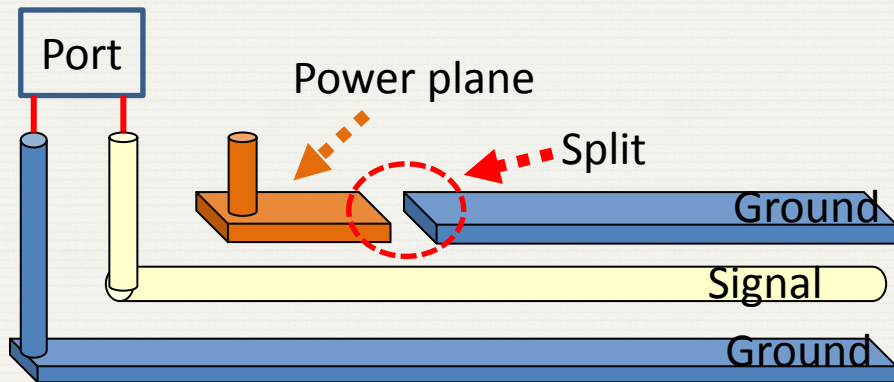


# Incorrect Channel Response by Conventional Automatic Port Setup



- Power and ground are shorted
  - Channel response looks too clean although we expect RPD
  - Is this right setup since ground plane dominates most of reference?

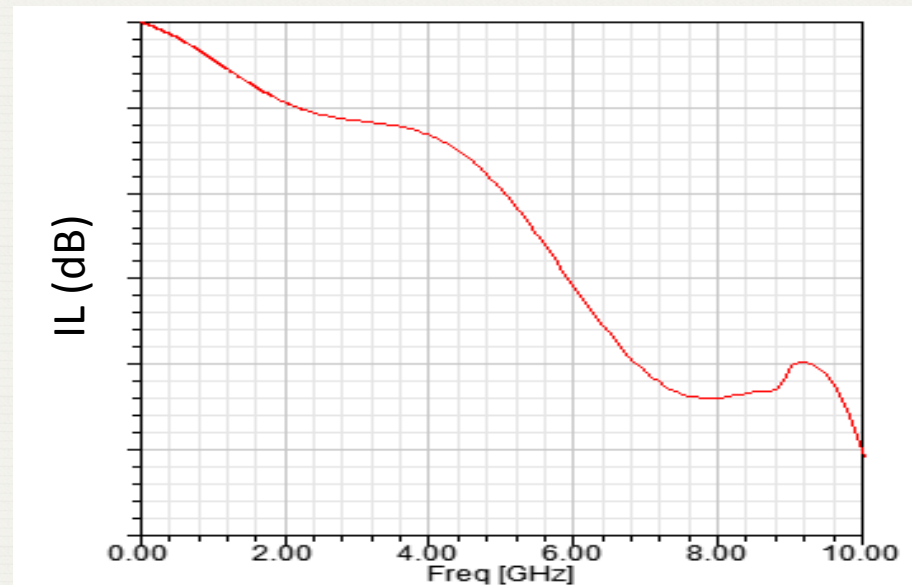
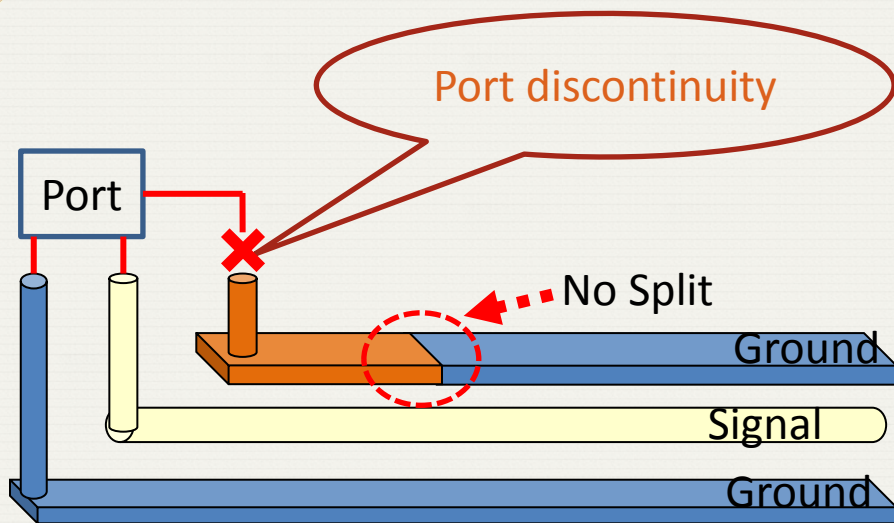
# Incorrect Channel Response by Conventional Manual Port Setup



- Power and ground are not shorted
  - Signal port is referenced to ground only
  - Huge resonant around 4 GHz
  - Is this false resonant caused by port discontinuity?

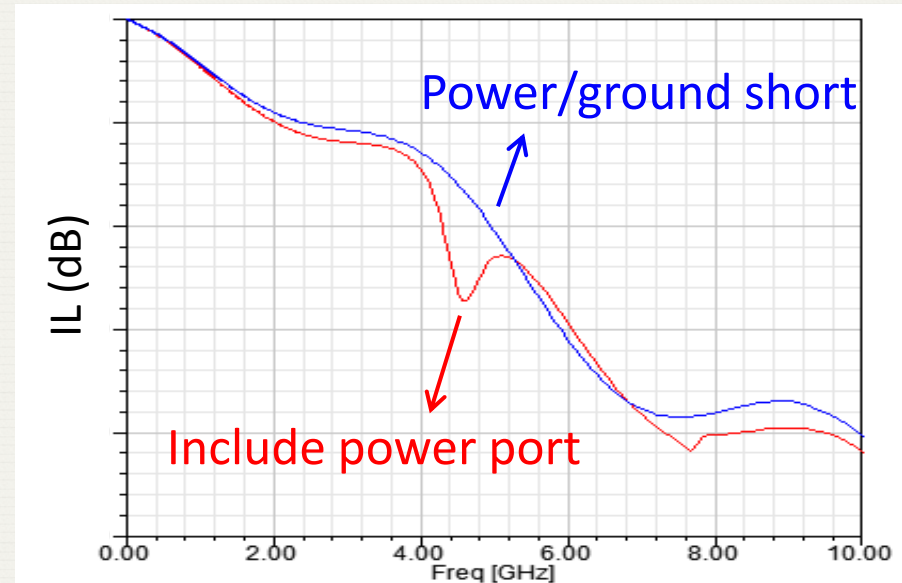
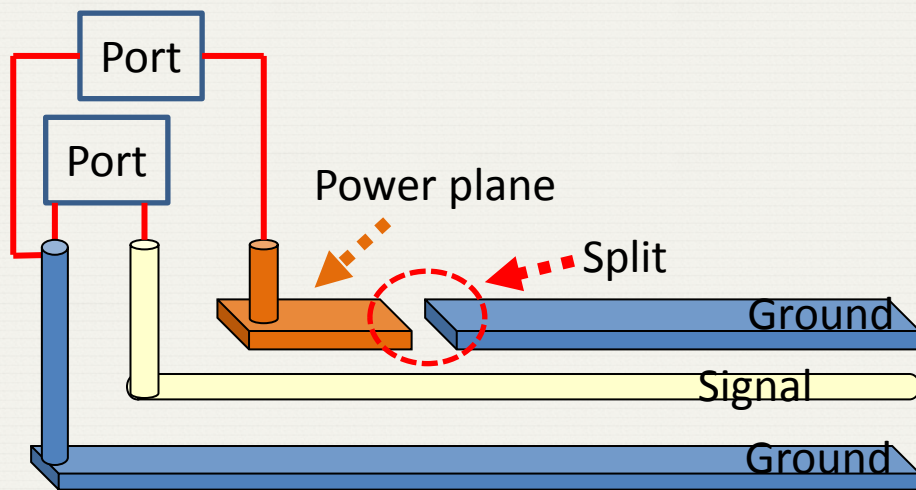


# Effect of Port Discontinuity



- Filled split, but maintain port discontinuity
  - No resonant in entire frequency range
  - Very similar result as power and ground short result

# Mixed-Reference Port Setup

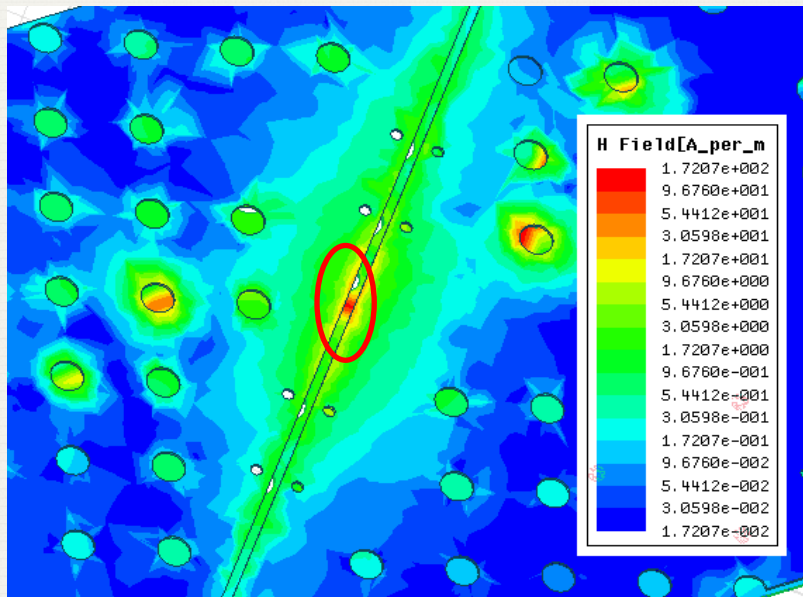


- Additional power port referenced to ground is needed
  - Capture return currents in both power and ground plane
  - Power port can be used for on-die connection for SI/PI co-analysis
  - Power/ground shorts changed return current flow

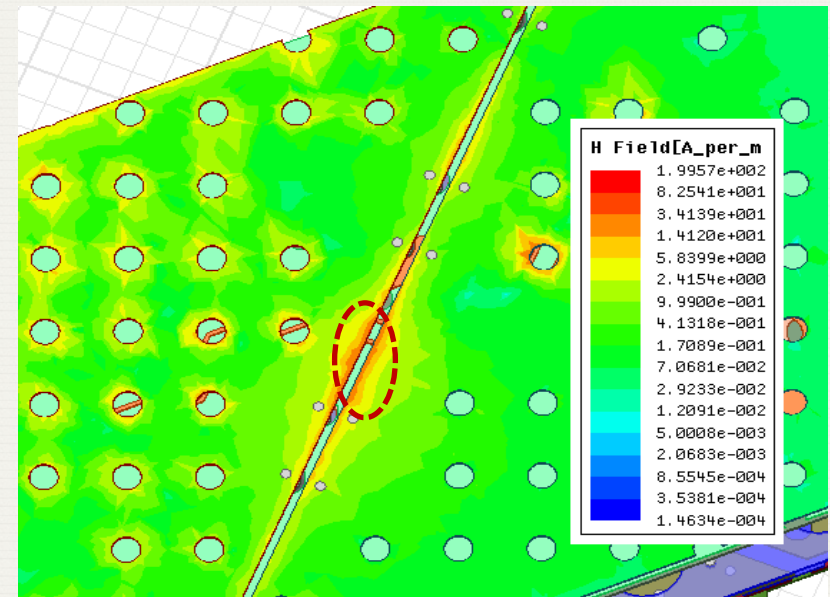


# Comparison of H-Field Distribution

With power port



No power port & power/ground short

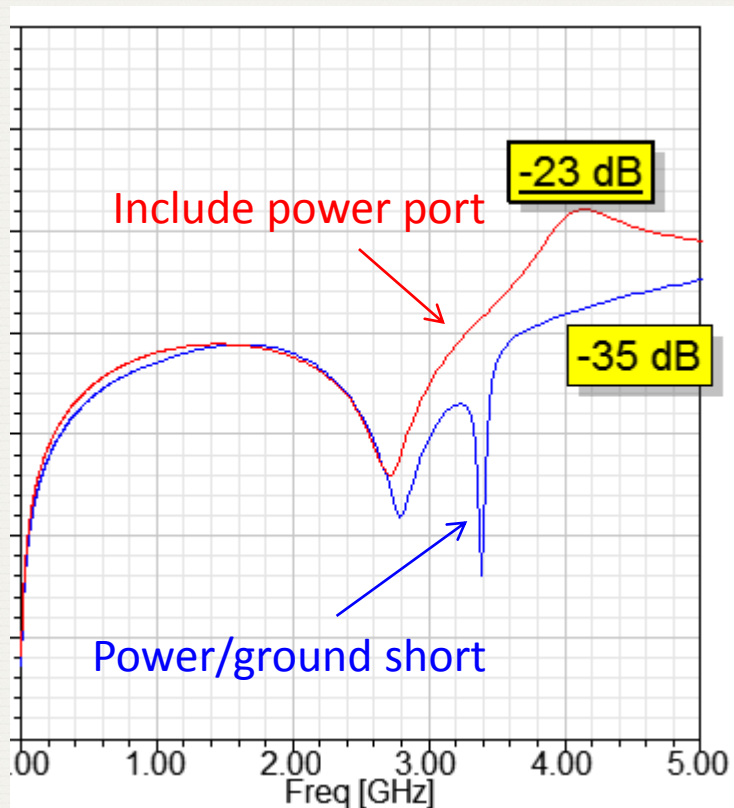


- The strongest field is seen at split region

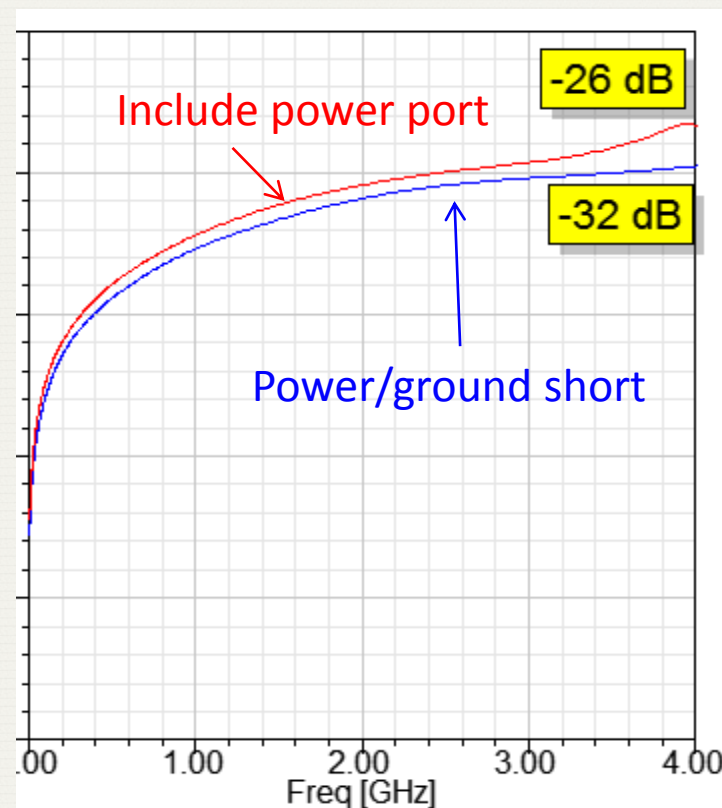
- Reduced magnitude of field at split
  - Demonstrates that RPD is mitigated by port setup

# Effect of Port Setup on Crosstalk Result

## Near-end crosstalk




## Far-end crosstalk



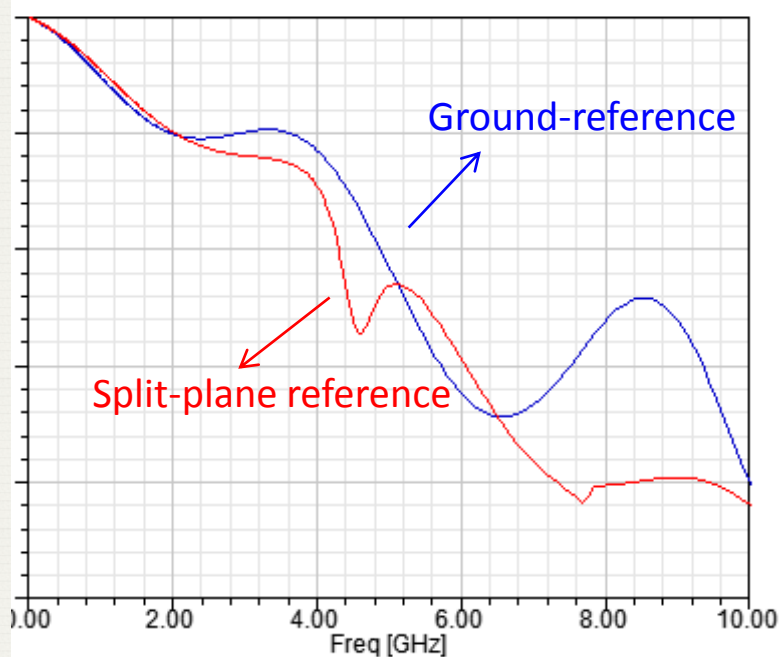
- Incorrect port setup provides optimistic crosstalk
  - Non-negligible difference between results
  - Deviation becomes higher as frequency increases



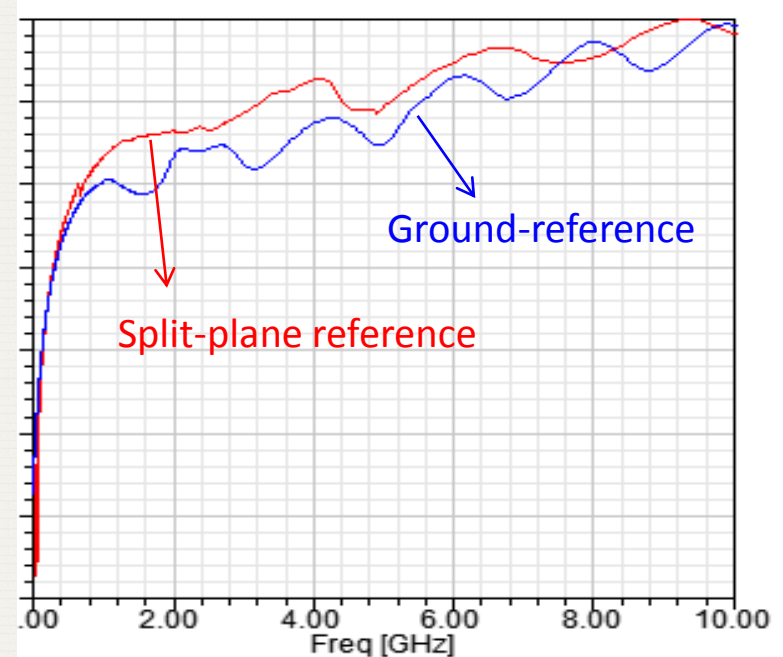
- 
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  - Mixed-Reference Analysis using 3D Tool
  - **Expected SI/PI Issues from Mixed-Reference**
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# Mixed-Reference vs Single-Reference in Channel Frequency Response

Insertion loss



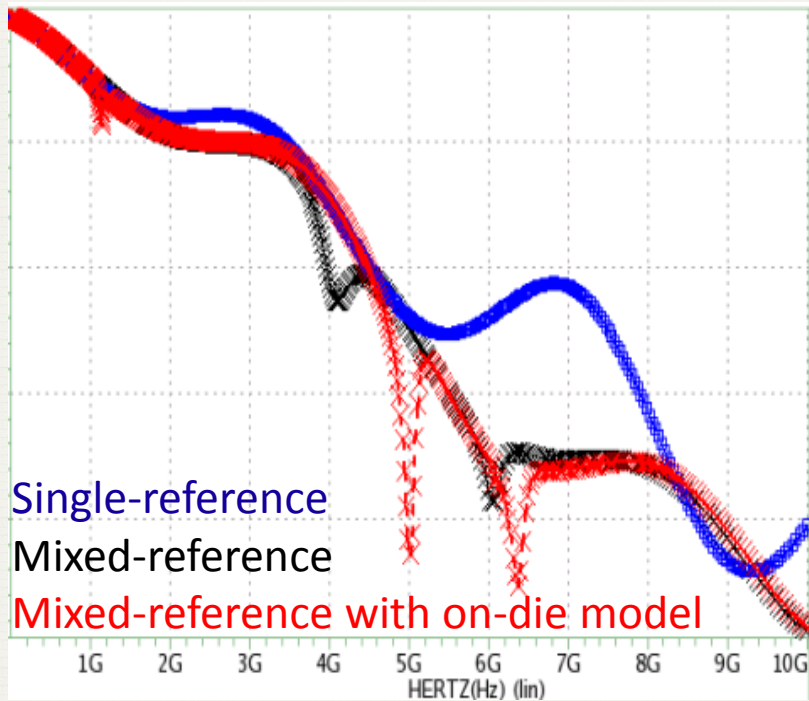
Crosstalk



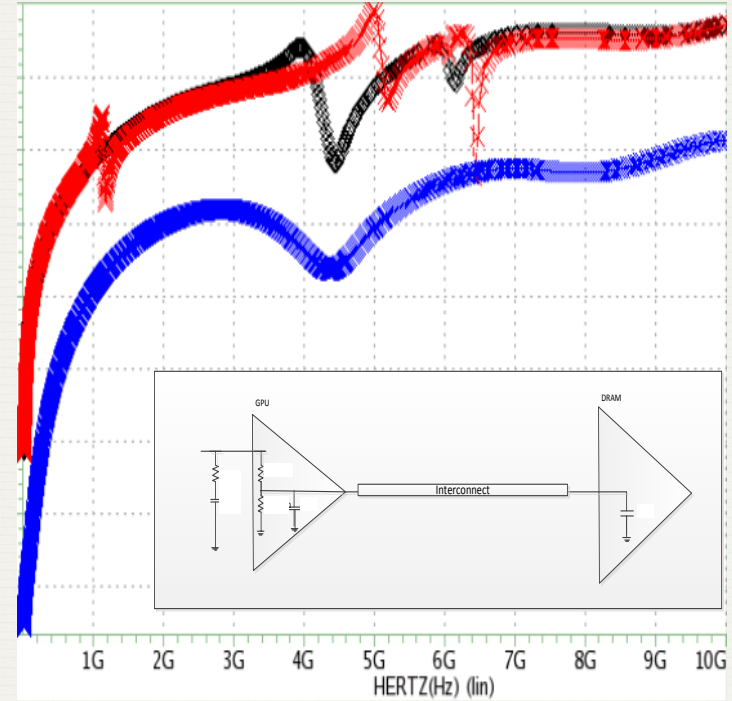
- Higher channel loss along with resonant
  - PKG + PCB result with the same channel length
- Higher crosstalk
  - Difficult to generalize crosstalk delta, but trace routing and space are the same condition

# Impact of On-Die Connection

Insertion loss



Far-end crosstalk

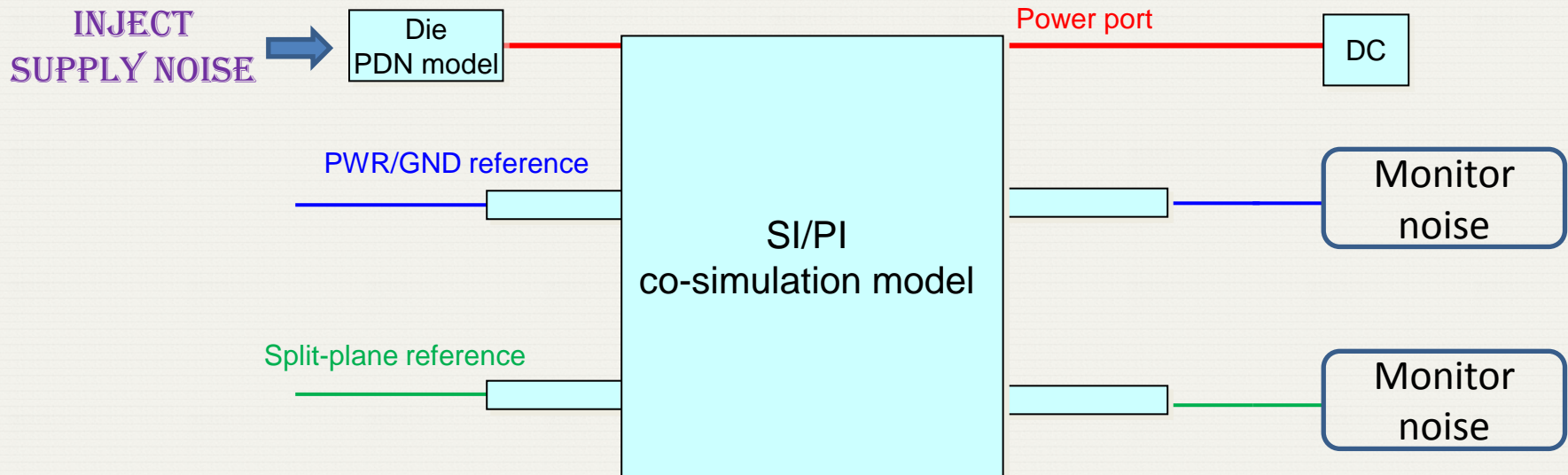


- Channel response of mixed-reference is affected by including on-die model
  - Capacitor in on-die model affects return current flow b/w power and ground



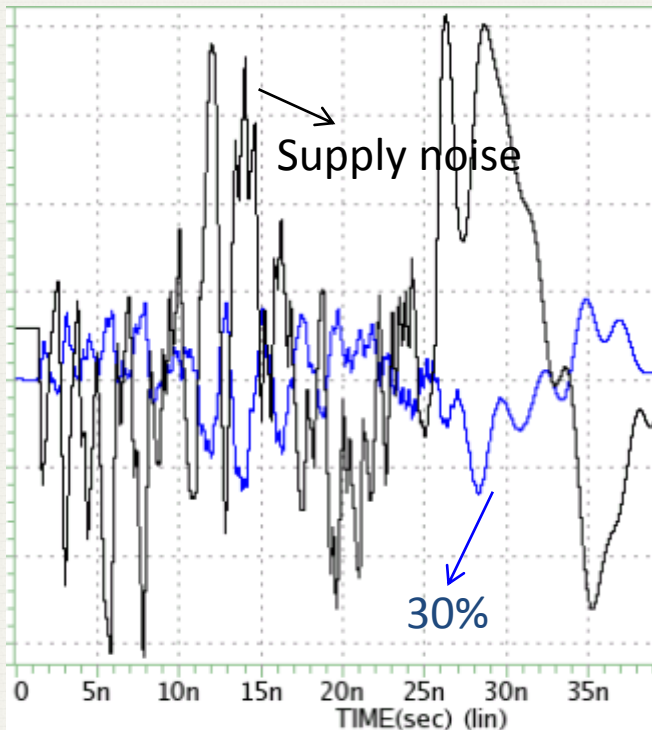
# Simulation Setup for Power Noise Coupling to Channel

- For mixed-reference, there is coupling between power plane and traces
- No circuit is switching to exclude ISI/crosstalk effect
- Channel is terminated to DC

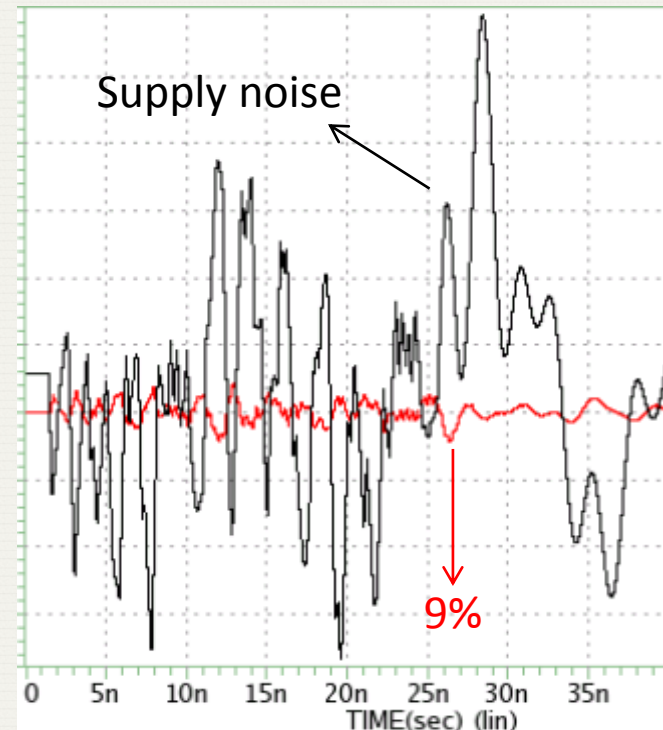


# Power Noise Coupling to Channel in Mixed-Reference

## Power/ground reference

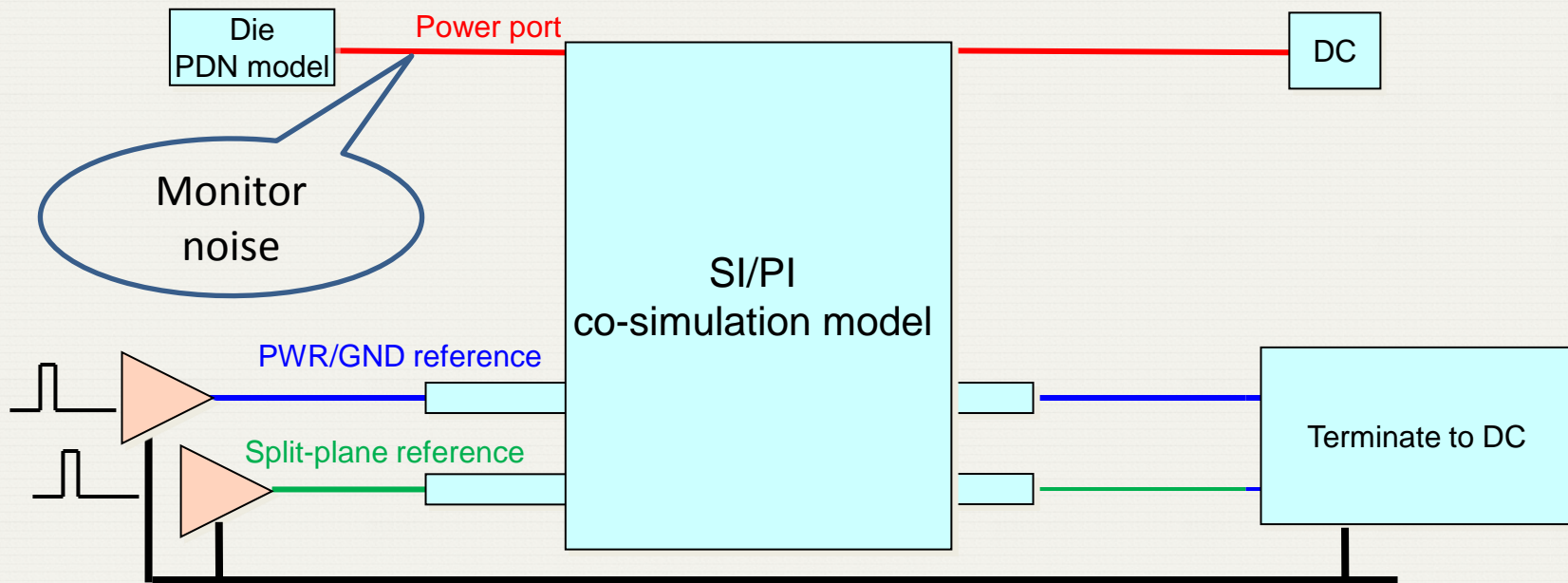


## Split-plane reference



- Supply noise and power noise coupled in trace are shown
  - Crosstalk is not included
- Power/ground reference shows higher coupled noise than split-plane reference

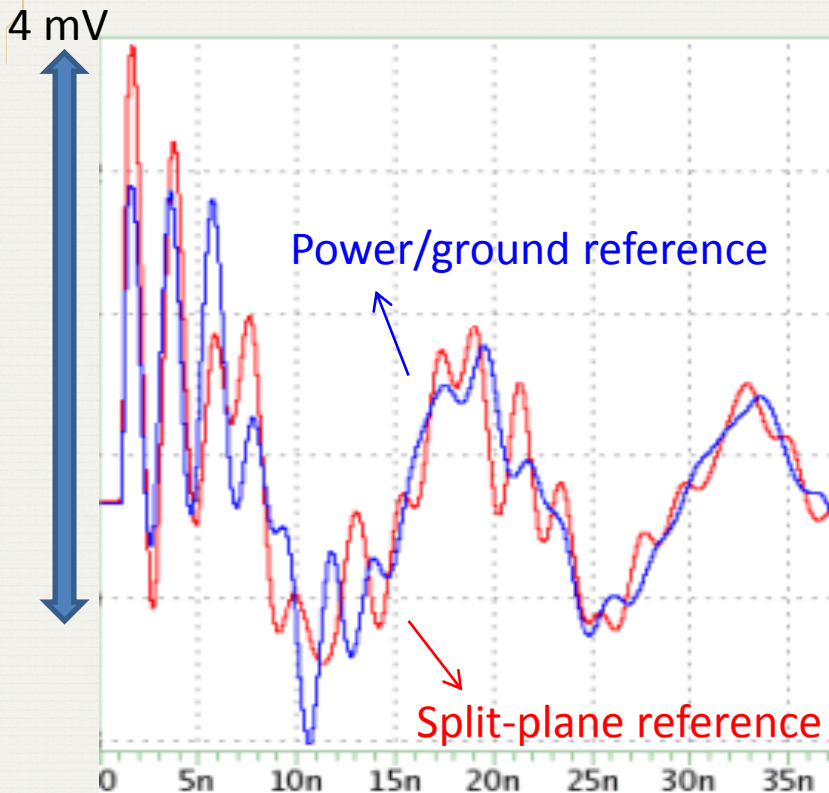
# Simulation Setup for Channel Induced Power Noise



- Hundreds of channels toggling in memory interface can add noise in power plane
- Power port is connected to ideal power supply
- Circuit is switching, but driver has ideal power connection




# Channel Induced Power Noise in Mixed-Reference



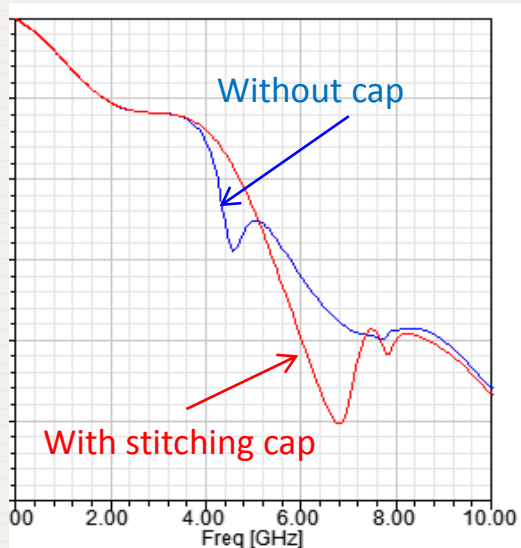
Noise seen in power plane  
by signal toggling

- Noise measured in power plane when signal is toggling
  - From only one aggressor
  - Very high noise is seen on power plane
  - $\sim 4\text{mV}$  noise after including on-die connection
- Mixed-reference may have higher power noise than single-reference
  - Impact of hundreds of aggressors may not be negligible

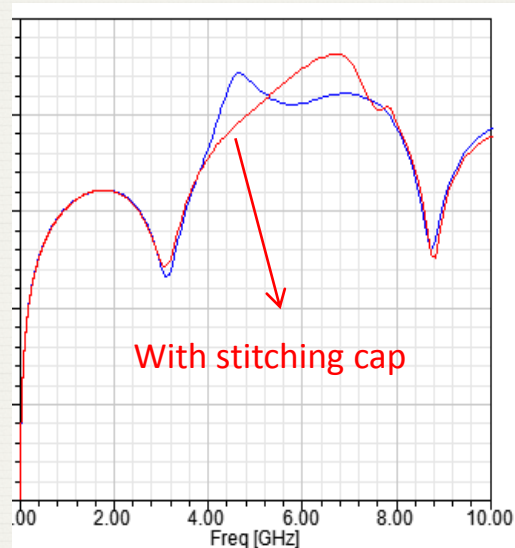
- 
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# Effectiveness of PKG Stitching Capacitors on Mixed-Reference

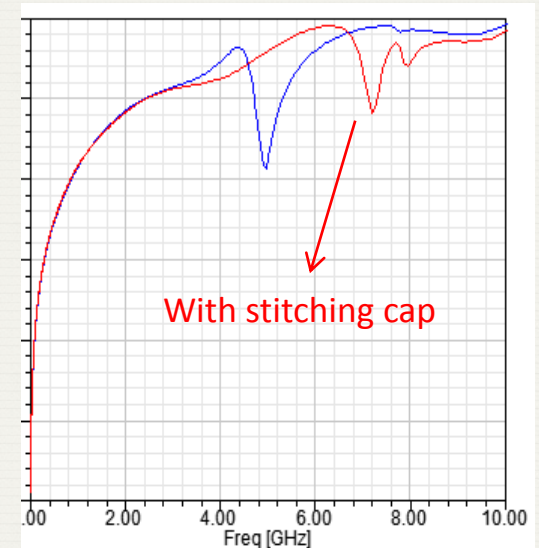
Insertion loss



Near-end crosstalk



Far-end crosstalk



- PKG caps are often used to reduce RPD caused by split
- PKG caps can provide AC current return path
  - Resulted in resonant shift
  - Effective frequency range is too narrow
  - Hard to say PKG cap improves crosstalk



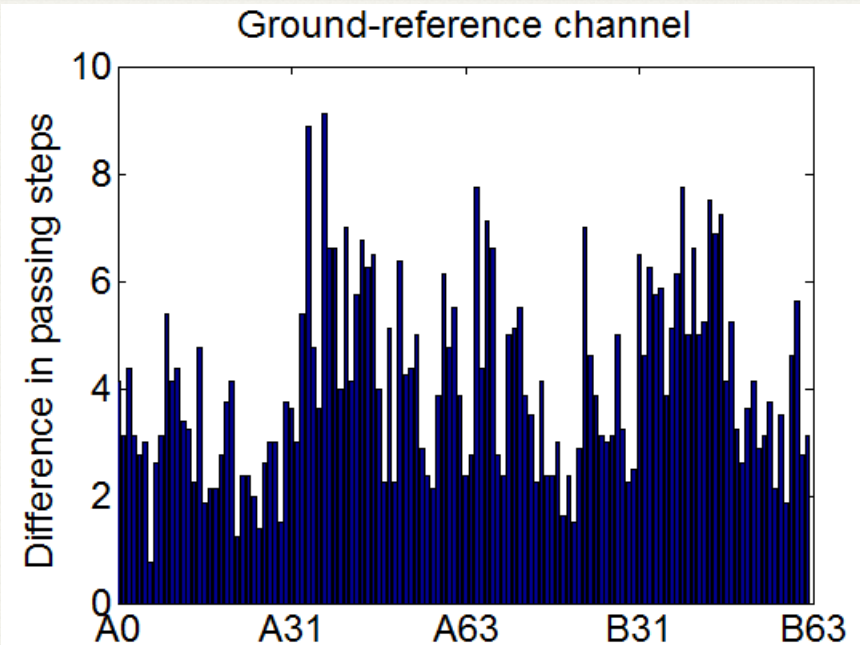
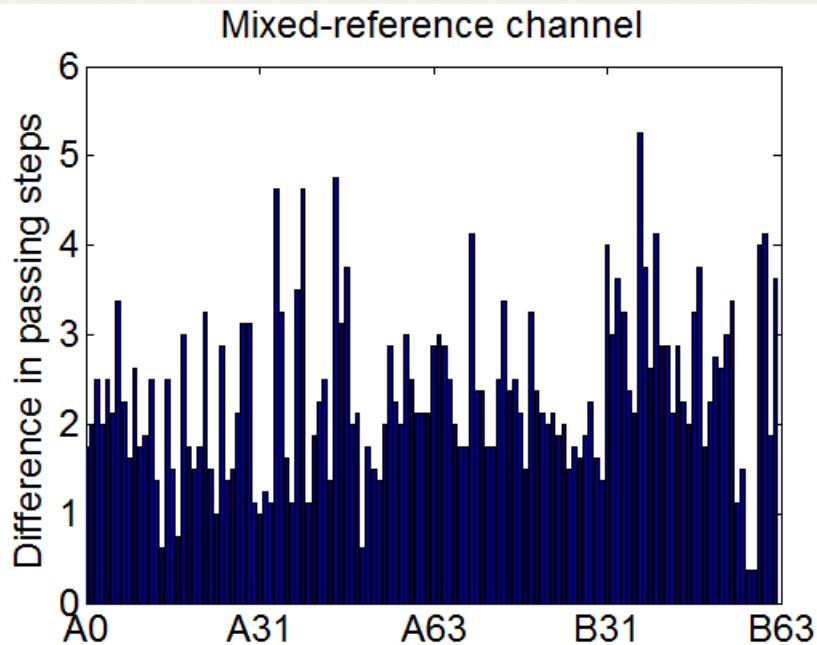
# System Level Measurement Case

- 6L package
  - Mixed-reference: Split-plane reference
- 8L package
  - Single-reference: Ground-reference
- Signal routings on both packages are exactly the same
- 6L package will save \$\$, but need to consider mixed-reference impact

# System Level Measurement Detail

- Characterization engine sweeps interpolator from -32 to +32 for every DQ signals and counting number of passing taps
- For measurement consistency, each measurement is repeated 8 times and averaged
  - PKG caps vs NO PKG caps
  - DBI on vs DBI off

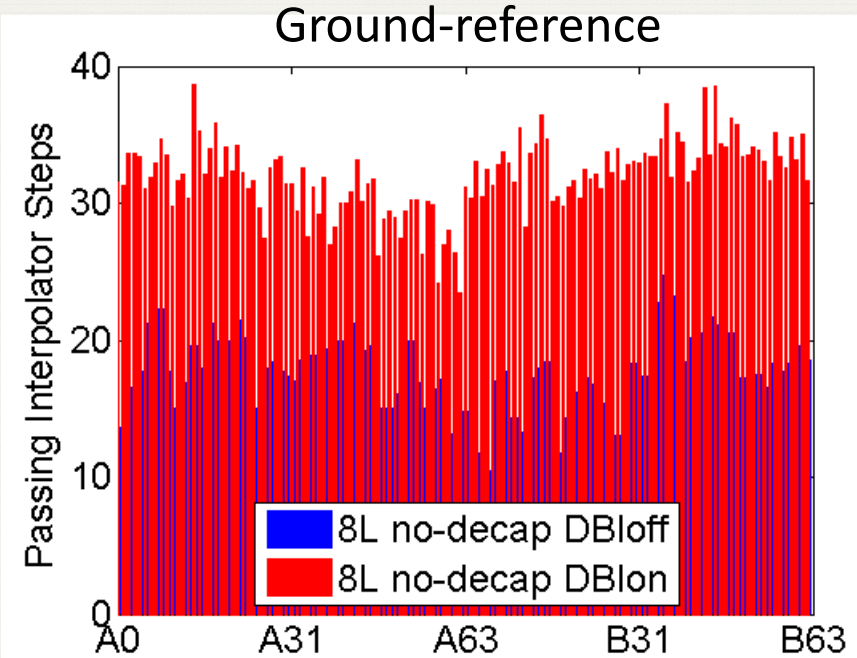
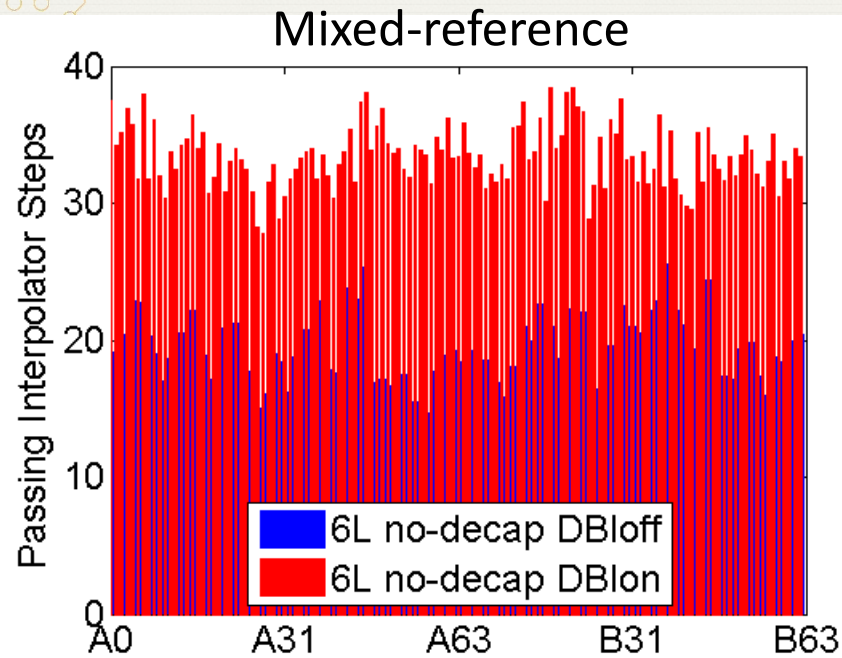
# Measurement Comparison of With and Without PKG Caps



- To distinguish the performance impact, measured data are subtracted from each other: with decaps case shows higher passing taps
- Performance difference by having PKG caps
  - Mixed-reference PKG: 0.03 UI Ground-reference PKG: 0.045 UI
- No clear distinction b/w 6L vs 8L



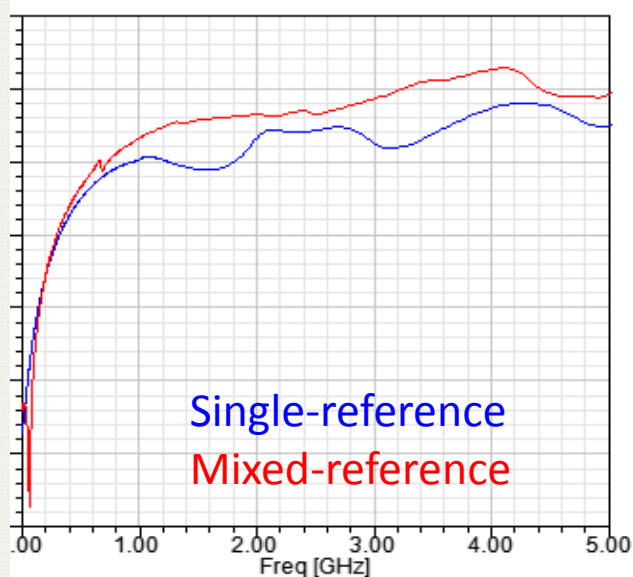
# Measurement Comparison of DBI Impact



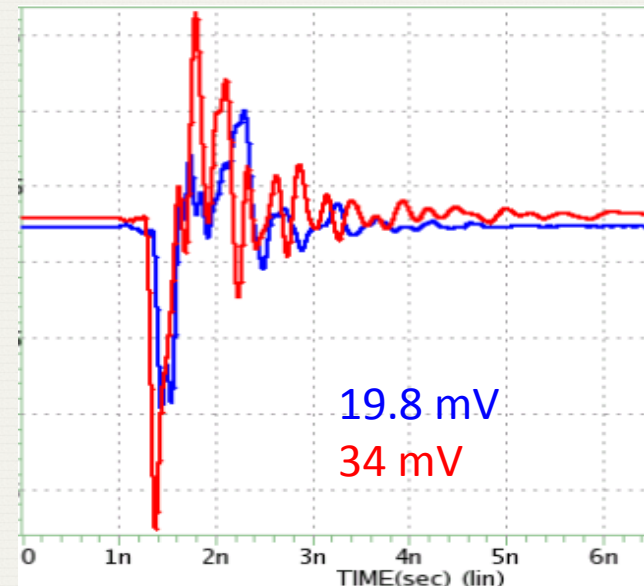
- All of PKG caps have been removed
- Impact of DBI is far significant than PKG caps
  - 0.23 UI for both 6 & 8L PKG
  - Mixed-reference does not increase overall sensitiveness of power noise

# Performance and Cost Trade Off

FEXT in frequency domain



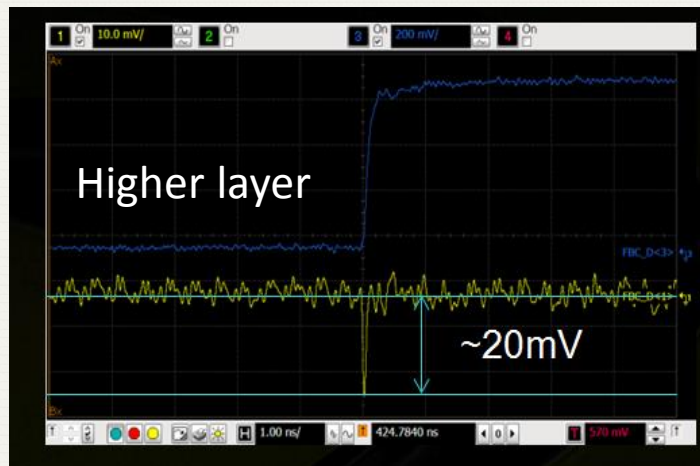
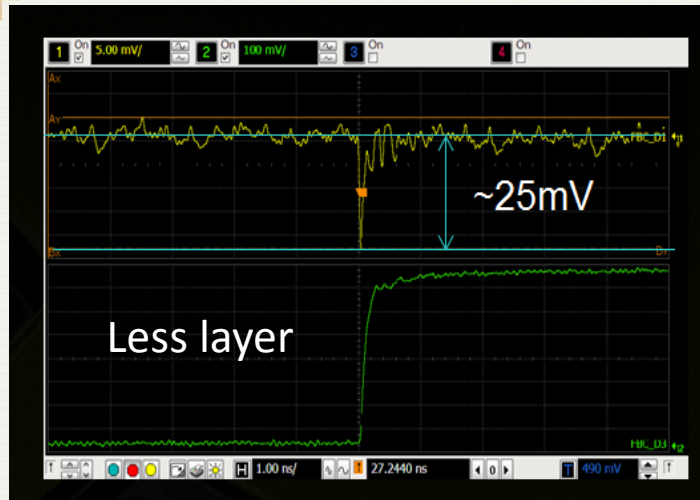
Crosstalk P2P noise



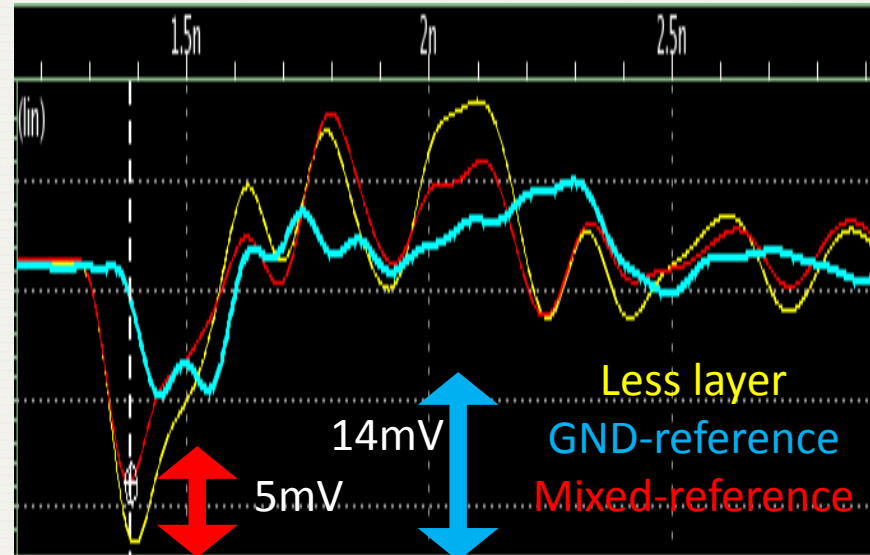
- Pursue higher layer count PKG for better performance with additional cost
- Within same PKG, there can be mixed-reference and ground-reference
  - Even with the same trace to trace spacing rule, crosstalk is dramatically different
  - 7~ 10 dB difference -> 70 % higher peak-to-peak crosstalk noise
- Performance will be limited by mixed-reference channel
  - Accurate mixed-reference analysis has to be used

# Mixed-Reference Crosstalk Correlation

## Measurement



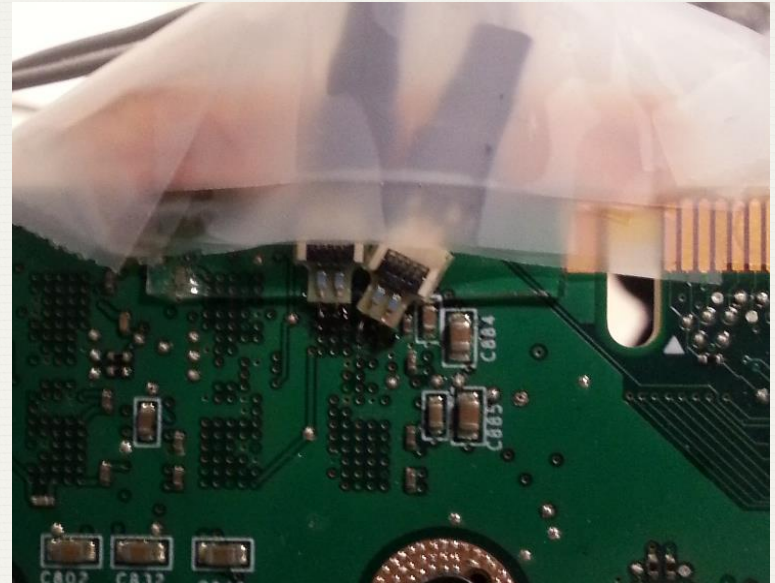
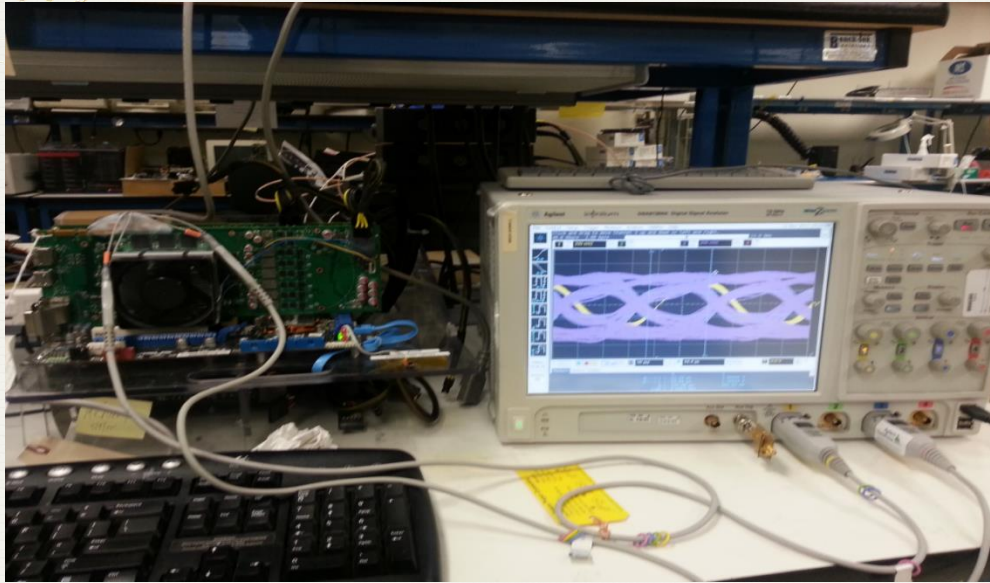
## Simulation



- Wanted 14mV less crosstalk noise from higher layer count package
- Measurement showed ~5 mV difference
- Considering mixed-reference channel, 5 mV difference in simulation
  - Split offsets 9 mV gain

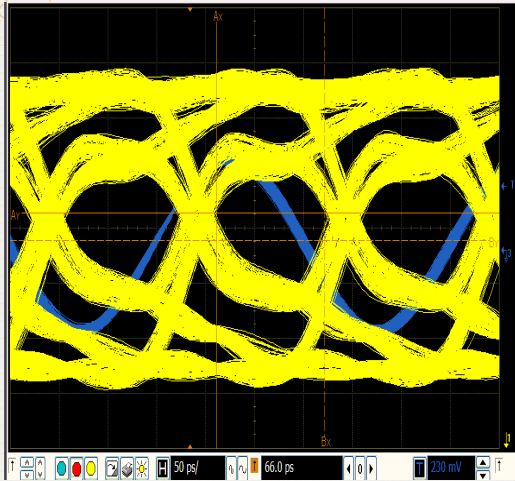


# Measurement Setup

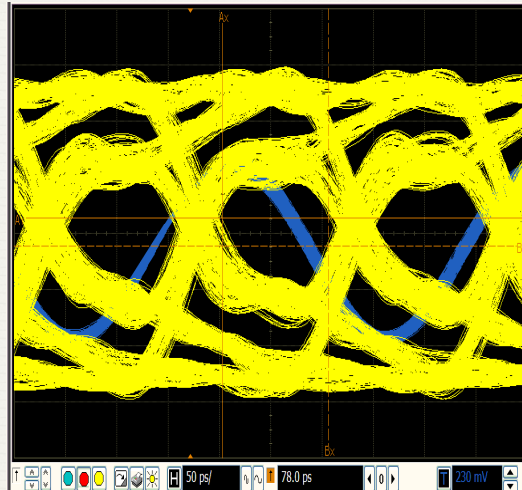


- Agilent Zif tip probes
  - Ensure short probe wire length to avoid artifact
  - 13 GHz to have high enough bandwidth
- PRBS7 is outputted by memory controller
- Signals are probed at the bottom of DRAM (x32)
- Measured channels have full trace coupling from PKG to PCB with similar length

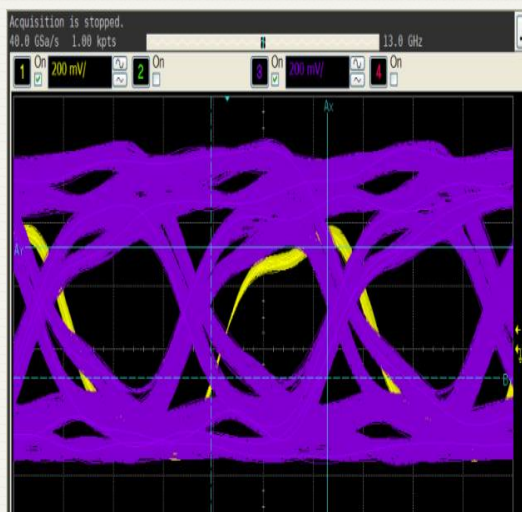
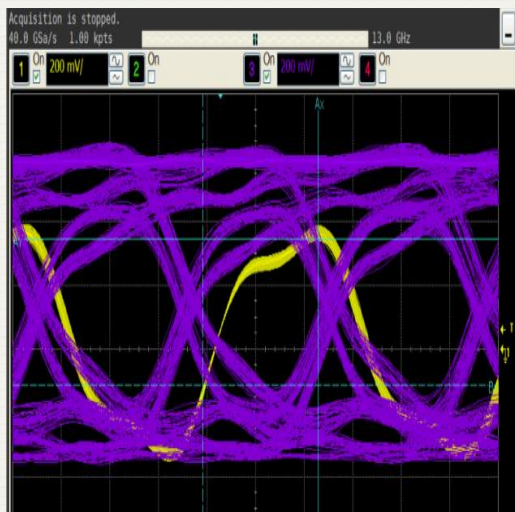
# Measured Eye-Diagram at 6.6 Gbps for Crosstalk Impact Difference



ISI



ISI + crosstalk

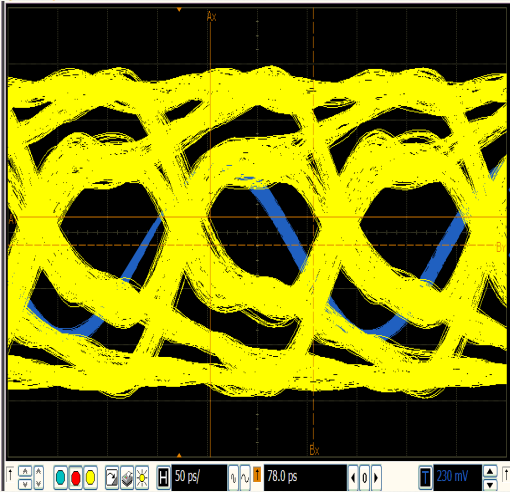


- 'ISI' has only one bit switching
- Bigger eye opening in single-reference channel
- 'ISI+crosstalk' has two aggressors switching
- Higher crosstalk impact in mixed-reference channel

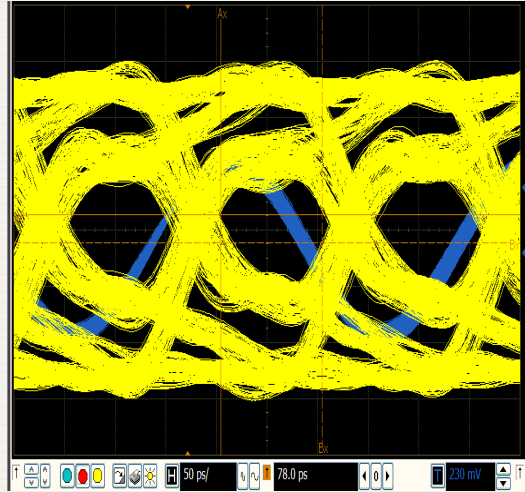


# Measured Eye-Diagram at 6.6 Gbps for Power Noise Impact Difference

Mixed-reference



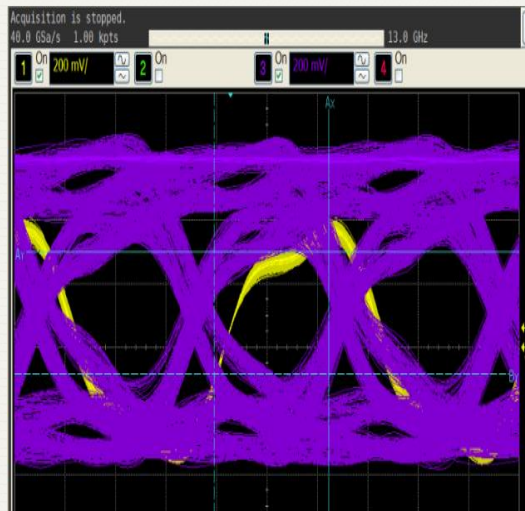
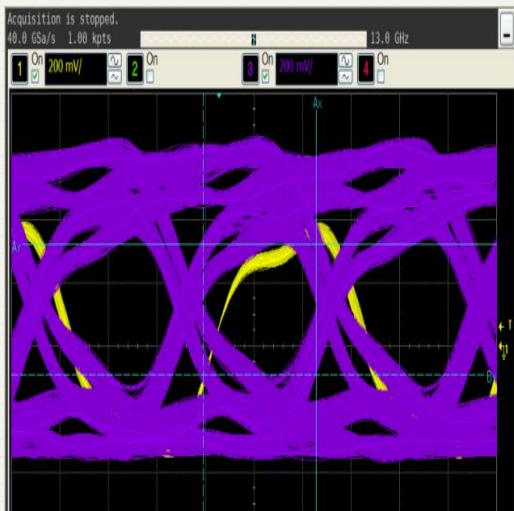
ISI + crosstalk



ISI + crosstalk + SSN

- 'ISI+crosstalk+SSN' has all memory bits switching
- There is no significant degradation in mixed-reference channel through power noise coupling

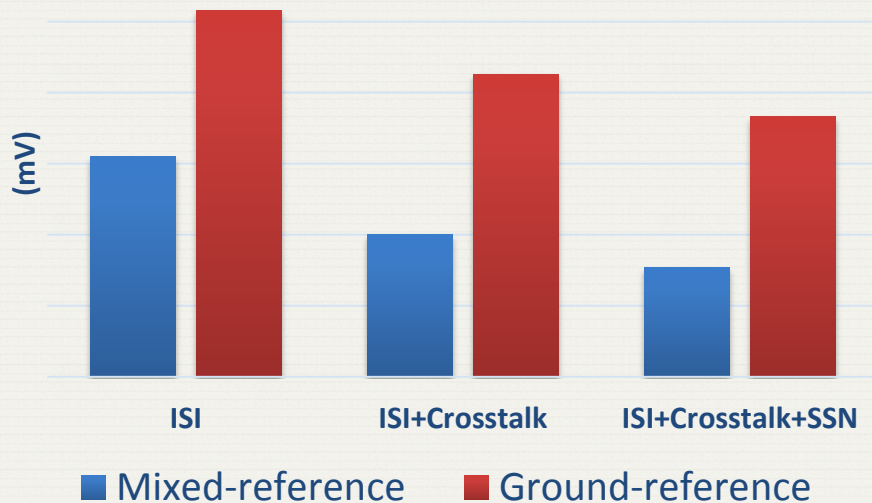
Single-reference



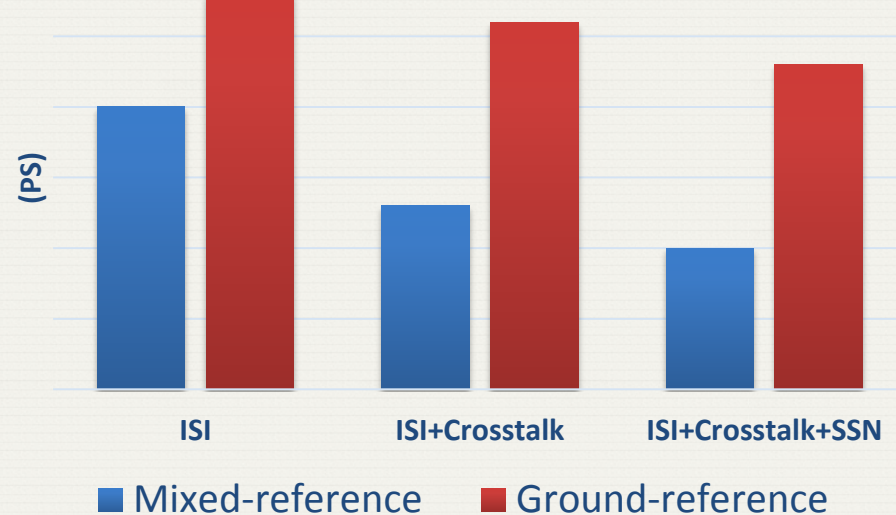


# Measurement Summary

## Eye-Height Comparison



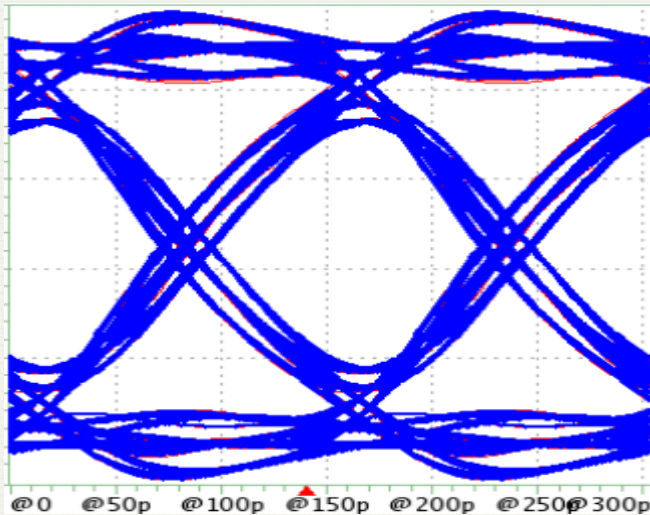
## Eye-Width Comparison



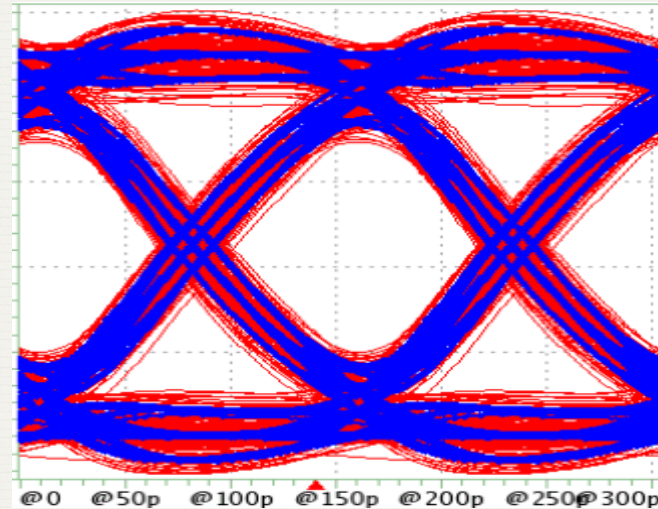
- Comparing ISI and ISI+Crosstalk
  - Mixed-reference
    - 16% EH & 6.3% EW reduction
  - Ground-reference
    - 10% EH & 1.7% EW reduction
- Slightly higher power noise impact on mixed-reference

# Demonstration of Power Noise Coupling in Mixed-Reference

Split-plane reference



Power/ground reference



- 6.6 Gbps PRBS7 without crosstalk
- Supply noise is applied to power port
  - Blue: without power noise
  - Red: adding power noise
- No noticeable difference in split-plane reference after adding power noise
- The impact of power noise coupling on power/ground reference is noticeably worse than split plane

# Summary

- SI/PI co-simulation of mixed-reference analysis using 3D tool has been introduced
  - Need to include power port
- Mixed-Reference impact on system performance has been demonstrated
  - Adding more PKG caps to compensate mixed-reference impact is not cost-effective
  - Split-plane reference adds more crosstalk
  - Non-negligible power noise coupling to trace should be considered for power/ground reference
- Analyzing SI/PI together will provide a better guidance on cost and performance optimization





THANKS!

Q/A